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CHIP COIL (CHIP INDUCTORS) LQG15WH□□□□02D Murata Standard Reference Specification [AEC-Q200]

1.Scope

This reference specification applies to LQG15WH series Chip Coil (Chip Inductors) for Automotive Electoronics based on AEC-Q200.

2.Part Numbering

(ex) LQ G 15 W S 0 D Product ID Struture Dimension Applications Category Inductance Tolerance Features Electrode Pakaging $(L \times W)$ for Automotive D:Taping Characteristics Electoronics

3.Rating

• Operating Temperature Range. -55°C to +125°C • Storage Temperature Range. -55°C to +125°C

- Storage Ten	nperature Hange.	−55°C to +125°			L D.O.	0.1(D				
Customer Part Number	MURATA Part Number	Inductance (nH)	Tolerance	Q (min.)	DC Resistance (Ω max.)	Self Resonant Frequency (MHz min.)	Rated Current	ESD Rank 1C:1kV		
T dit Number	T dit Number		(*1)(refer t	o belov	w comment)	(*****)	(mA)			
	LQG15WH0N7B02D									
	LQG15WH0N7C02D	0.7								
	LQG15WH0N7S02D									
	LQG15WH0N8B02D									
	LQG15WH0N8C02D	8.0								
	LQG15WH0N8S02D					15000				
	LQG15WH0N9B02D					15000				
	LQG15WH0N9C02D	0.9								
	LQG15WH0N9S02D									
	LQG15WH1N0B02D									
	LQG15WH1N0C02D	1.0		-	0.03		1200			
	LQG15WH1N0S02D									
	LQG15WH1N1B02D									
	LQG15WH1N1C02D	1.1 1.2 B:±0.1n				14000	-			
	LQG15WH1N1S02D									
	LQG15WH1N2B02D]							
	LQG15WH1N2C02D		1.2 B:±0.1nH			13000				
	LQG15WH1N2S02D									
	LQG15WH1N3B02D									
	LQG15WH1N3C02D	1.3	C:±0.2nH					1C		
	LQG15WH1N3S02D		S:±0.3nH			10000				
	LQG15WH1N4B02D]			12000		
	LQG15WH1N4C02D	1.4	1.4							
	LQG15WH1N4S02D									
	LQG15WH1N5B02D									
	LQG15WH1N5C02D	1.5				11000				
	LQG15WH1N5S02D									
	LQG15WH1N6B02D									
	LQG15WH1N6C02D	1.6			0.04					
	LQG15WH1N6S02D			00		10000	1000			
	LQG15WH1N7B02D]	23		10000	1000			
	LQG15WH1N7C02D	1.7								
	LQG15WH1N7S02D									
	LQG15WH1N8B02D									
	LQG15WH1N8C02D					9000				
	LQG15WH1N8S02D									
	LQG15WH1N9B02D									
	LQG15WH1N9C02D	1.9			0.05	8000				
	LQG15WH1N9S02D									

Customer Part Number	SpecNo.JELF243B-9	9118B-01	- 1 	CIIC			• y	P.	2 / 11
LOG15WH2N0602D LOG15WH3N0602D LOG1	Customer	MURATA			(min.)	Resistance (Ω max.)	Frequency	Rated Current	ESD Rank
LOG15WH2NOC22D 2.0				(*1)(refer t	o belov	v comment)		(**** *)	
LOG15WH2NDS02D		LQG15WH2N0B02D							
LOG15WH2N1G02D LOG15WH2N2G02D LOG15WH2N2G02D LOG15WH2N2G02D LOG15WH2N2G02D LOG15WH2N2G02D LOG15WH2NS002D LOG15WH3NS002D LOG1			2.0			0.05			
LOG ISWHENROOZD 2.1		LQG15WH2N0S02D							
LOGISWHENSO2D LOGISWHENSO2		LQG15WH2N1B02D							
LOG ISWHENDOOZD 2.2		LQG15WH2N1C02D	2.1				8000		
COG15WH2NB002D COG15WH3NB002D COG1		LQG15WH2N1S02D				0.06			
LGG15WH2NS020D LOG15WH2NS020D LOG15WH3NS020D LOG1		LQG15WH2N2B02D				0.06			
LGG15WH2N3S02D		LQG15WH2N2C02D	2.2					1000	
LGG15WH2N3C02D 2.3 LGG15WH2N4B02D LGG15WH2N4B02D LGG15WH2N4B02D LGG15WH2N4B02D LGG15WH2N8D02D LGG15WH3ND002D LGG15WH3NS002D LGG15WH3NS002D		LQG15WH2N2S02D							
LGG15WH2N3C02D 2.3 LGG15WH2N4B02D LGG15WH2N4B02D LGG15WH2N4B02D LGG15WH2N4B02D LGG15WH2N8D02D LGG15WH3ND002D LGG15WH3NS002D LGG15WH3NS002D		LQG15WH2N3B02D							
LQG15WH2N4S02D			2.3			0.07	7000		
LQG15WH2N4B02D 2.4									
LQG15WH2N4C02D				1					
LOG15WH2NS02D LOG15WH2NS02D 2.5			24			0.06			
LOG15WH2NSD02D 2.5 LOG15WH2NSD02D 2.5 LOG15WH2NSD02D 2.6 LOG15WH2NSD02D 2.6 LOG15WH2NSD02D 2.6 LOG15WH2NSD02D 2.7 LOG15WH2NSD02D 2.7 LOG15WH2NSD02D 2.8 LOG15WH2NSD02D 2.8 LOG15WH2NSD02D 2.9 C:±0.2nH S:±0.3nH S:±0.3nH LOG15WH2NSD02D 2.9 C:±0.3nH S:±0.3nH LOG15WH3NSD02D 2.9 C:±0.2nH S:±0.3nH S:±0.3nH S:±0.3nH LOG15WH3NSD02D 2.9 C:±0.2nH S:±0.3nH S:±0.3nH S:±0.3nH LOG15WH3NSD02D 2.9 C:±0.2nH S:±0.3nH S:						0.00			
LOG15WH2NSC02D 2.5 LOG15WH2NSC02D 2.6 LOG15WH2NSC02D 2.6 LOG15WH2NSC02D 2.6 LOG15WH2NSC02D 2.6 LOG15WH2NSC02D 2.7 LOG15WH2NSC02D 2.7 LOG15WH2NSC02D 2.7 LOG15WH2NSC02D 2.8 LOG15WH2NSC02D 2.8 LOG15WH2NSC02D 2.9 C:±0.2nH 2.3 0.08 LOG15WH2NSC02D 2.9 C:±0.2nH 2.3 0.08 LOG15WH3NSC02D 3.0 LOG15WH3NSC02D 3.0 LOG15WH3NSC02D 3.1 LOG15WH3NSC02D 3.1 LOG15WH3NSC02D 3.2 LOG15WH3NSC02D LOG15WH3NSC02D LOG15WH3NSC02D LOG15WH3NSC02D 3.2 LOG15WH3NSC02D 3.6 LOG15WH3NSC02D 3.6 LOG15WH3NSC02D LOG15WH3NSC02D 3.7 LOG15WH3NSC02D 3.7 LOG15WH3NSC02D 3.8 5000				1					
LQG15WH2NBG02D LQG15WH2NBG02D LQG15WH2NBG02D LQG15WH2NF002D LQG15WH2NF002D LQG15WH2NF002D LQG15WH2NBG02D LQG15WH3NNBG02D LQG15WH3NNBG02D LQG15WH3NNBG02D LQG15WH3NNBG02D LQG15WH3NNBG02D LQG15WH3NSD02D			25						
LQG15WH2NBG02D LQG15WH2NBG02D LQG15WH2NBG02D LQG15WH2NFS02D LQG15WH2NFS02D LQG15WH2NBG02D LQG15WH2NBG02D LQG15WH2NBG02D LQG15WH2NBG02D LQG15WH2NBG02D LQG15WH2NBG02D LQG15WH2NBG02D LQG15WH3N0G02D LQG15WH3NNG02D LQG15WH3NNG02D LQG15WH3NNG02D LQG15WH3NNG02D LQG15WH3NNG02D LQG15WH3NDG02D LQG15WH3NDG02D LQG15WH3NDG02D LQG15WH3NDG02D LQG15WH3NS02D LQG15W			2.5						
LQG15WH2N6C02D 2.6 LQG15WH2NF802D 2.7 LQG15WH2N7S02D 2.7 LQG15WH2N7S02D 2.8 LQG15WH2N8S02D 2.8 LQG15WH2N8S02D 2.9 C:±0.2nH LQG15WH2N9S02D 2.9 C:±0.2nH LQG15WH3N9S02D 2.9 C:±0.3nH LQG15WH3N9S02D 2.9 C:±0.3nH LQG15WH3N9S02D 3.0 LQG15WH3N9S02D 3.1 LQG15WH3N1C02D 3.1 LQG15WH3N1S02D 1.0G15WH3N8D02D 1.0G15WH3N8D02D LQG15WH3N1S02D 1.0G15WH3N8D02D 1.0G15WH3N8D02D 1.0G15WH3N8D02D LQG15WH3N3C02D 3.2 1.0G15WH3N3S02D 1.0G15WH3N3S02D 1.0G15WH3N4S02D 1.0G15WH3N4S02D 1.0G15WH3N4S02D 1.0G15WH3N4S02D 1.0G15WH3N4S02D 1.0G15WH3N4S02D 1.0G15WH3N4S02D 1.0G15WH3N4S02D 1.0G15WH3N4S02D 1.0G15WH3N502D 1.0G15WH				1					
LQG15WH2NR502D LQG15WH3NR502D LQG15WH3NR			2.6			0.07			
LQG15WH2N702D 2.7 LQG15WH2N702D 2.7 LQG15WH2N802D 1.0 LQG15WH2N802D 2.8 LQG15WH2N802D 2.8 LQG15WH2N902D 2.9 1.0 LQG15WH2N902D 2.9 1.0 LQG15WH3N0802D 2.9 1.0 LQG15WH3N0802D 2.9 1.0 LQG15WH3NN002D 2.9 1.0 LQG15WH3NN002D 3.0 LQG15WH3NN002D 3.0 LQG15WH3N102D 3.1 LQG15WH3N102D 1.0 LQG15WH3N102D 1.0 LQG15WH3N2S02D 1.0 LQG15WH3N2S02D 1.0 LQG15WH3N3S02D 1.0 LQG15WH3NS02D 1.0 LQG			2.0			0.07			
LQG15WH2N7C02D 2.7 LQG15WH2NR02D 2.8 LQG15WH2NB02D 2.8 LQG15WH2NB02D 2.9 C:±0.2nH LQG15WH2NB02D 2.9 C:±0.2nH LQG15WH2NB002D 2.9 C:±0.2nH LQG15WH2NB002D 3.0 LQG15WH3N0002D 3.0 LQG15WH3N0002D 3.0 LQG15WH3N1B02D 1.0 LQG15WH3N1B02D 1.0 LQG15WH3N1S02D 3.1 LQG15WH3N1S02D 1.0 LQG15WH3N1S02D 3.2 LQG15WH3N2S02D 1.0 LQG15WH3N2S02D 1.0 LQG15WH3N3S02D 1.0 LQG15WH3N4S02D 1.0 LQG15WH3NS02D 1.0				4			6500		
LQG15WH2N7S02D			0.7						
LOG15WH2N8B02D LOG15WH2N8B02D LOG15WH2N9B02D LOG15WH2N9B02D LOG15WH2N9B02D LOG15WH2N9S02D LOG15WH3N0B02D LOG15WH3N0B02D LOG15WH3N0B02D LOG15WH3N1B02D LOG15WH3N1B02D LOG15WH3N1B02D LOG15WH3N1B02D LOG15WH3N1S02D LOG15WH3N1S02D LOG15WH3N1S02D LOG15WH3N3S02D LOG15WH3N3S02D LOG15WH3N3S02D LOG15WH3N3S02D LOG15WH3N3S02D LOG15WH3N4B02D LOG15WH3N4B02D LOG15WH3N4B02D LOG15WH3N4B02D LOG15WH3N4B02D LOG15WH3N8B02D LOG15WH3N8B02D LOG15WH3N8B02D LOG15WH3N8B02D LOG15WH3N8B02D LOG15WH3N8B02D LOG15WH3N8B02D LOG15WH3N6B02D LOG15WH3N6B02D LOG15WH3N6B02D LOG15WH3N6B02D LOG15WH3N6B02D LOG15WH3N7B02D LOG15WH3N8B02D LOG15WH3N8B02D LOG15WH3N7B02D LOG15WH3N8B02D LOG15WH3NB02D L			2.7						
LQG15WH2N8C02D LQG15WH2N9B02D LQG15WH2N9B02D LQG15WH2N9S02D S:±0.3nH S:±0.3nH S:±0.3nH C:±0.2nH S:±0.3nH S:±0.3				4					
LQG15WH2N8S02D			0.0						
LQG15WH2N9B02D 2.9 B:±0.1nH C:±0.2nH S:±0.3nH C:±0.2nH S:±0.3nH C:±0.2nH S:±0.3nH S:±0.3n			2.8						
LQG15WH2N9S02D									
LQG15WH2N9S02D LQG15WH3N0B02D LQG15WH3N0S02D LQG15WH3N0S02D LQG15WH3N1C02D 3.0									
LQG15WH3N0602D 3.0 LQG15WH3N10602D LQG15WH3N1802D LQG15WH3N1502D LQG15WH3N1502D LQG15WH3N12B02D LQG15WH3N2B02D LQG15WH3N2S02D LQG15WH3N2S02D LQG15WH3N3S02D LQG15WH3N3S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N5S02D LQG15WH3N4S02D LQG15WH3N5S02D LQG15WH3N6S02D LQG15WH3N6S02D LQG15WH3N6S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N8S02D LQG15WH3N8S02D L			2.9		23	0.08			1C
LQG15WH3N0C02D 3.0 LQG15WH3N1B02D LQG15WH3N1S02D LQG15WH3N1S02D LQG15WH3N1S02D LQG15WH3N2S02D LQG15WH3N2S02D LQG15WH3N3S02D LQG15WH3N3S02D LQG15WH3N3S02D LQG15WH3N4B02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3NSS02D LQG15WH3NSS				S:±0.3nH					
LQG15WH3N1B02D LQG15WH3N1C02D LQG15WH3N1S02D LQG15WH3N2S02D LQG15WH3N2S02D LQG15WH3N2S02D LQG15WH3N3B02D LQG15WH3N3S02D LQG15WH3N3S02D LQG15WH3N4B02D LQG15WH3N4B02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N5S02D LQG15WH3N5S02D LQG15WH3N6S02D LQG15WH3N7S02D LQG15WH3N8S02D LQG15WH3N8S02D									
LQG15WH3N1B02D 3.1			3.0						
LQG15WH3N1C02D 3.1									
LQG15WH3N1S02D		LQG15WH3N1B02D							
LQG15WH3N2E02D 3.2 6000 LQG15WH3N2S02D 3.2 6000 LQG15WH3N2S02D 3.3 0.08 LQG15WH3N3S02D 3.3 0.08 LQG15WH3N3S02D 3.4 LQG15WH3N4S02D 3.4 LQG15WH3N4S02D 3.5 0.09 5800 LQG15WH3N5S02D 3.5 0.09 5800 LQG15WH3N6S02D 3.6 LQG15WH3N6S02D 3.6 LQG15WH3N6S02D 3.6 LQG15WH3N7S02D 3.7 LQG15WH3N7S02D 3.7 LQG15WH3N7S02D 1.010 LQG15WH3N7S02D 1.010 LQG15WH3N7S02D 1.010 LQG15WH3N8B02D		LQG15WH3N1C02D	3.1						
LQG15WH3N2S02D 3.2 6000 LQG15WH3N2S02D		LQG15WH3N1S02D				0.00		000	
LQG15WH3N2S02D LQG15WH3N3B02D LQG15WH3N3S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N5B02D LQG15WH3N5S02D LQG15WH3N5S02D LQG15WH3N6B02D LQG15WH3N6B02D LQG15WH3N6S02D LQG15WH3N7S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D S500		LQG15WH3N2B02D				0.09		900	
LQG15WH3N3B02D LQG15WH3N3C02D LQG15WH3N4B02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N4S02D LQG15WH3N5S02D LQG15WH3N5S02D LQG15WH3N6B02D LQG15WH3N6S02D LQG15WH3N6S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D		LQG15WH3N2C02D	3.2				6000		
LQG15WH3N3C02D 3.3 LQG15WH3N3S02D 0.08 LQG15WH3N4B02D 3.4 LQG15WH3N4S02D 3.4 LQG15WH3N5B02D 0.09 LQG15WH3N5C02D 3.5 LQG15WH3N5S02D 0.09 LQG15WH3N6B02D 0.09 LQG15WH3N6C02D 3.6 LQG15WH3N6S02D 0.09 LQG15WH3N7B02D 0.10 LQG15WH3N7S02D 0.10 LQG15WH3N8B02D 0.10 LQG15WH3N8B02D 0.10 LQG15WH3N8C02D 3.8		LQG15WH3N2S02D							
LQG15WH3N4S02D LQG15WH3N4C02D 3.4 LQG15WH3N4S02D LQG15WH3N5S02D LQG15WH3N5S02D LQG15WH3N6B02D LQG15WH3N6B02D LQG15WH3N6S02D LQG15WH3N6S02D LQG15WH3N7B02D LQG15WH3N7B02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D S5000		LQG15WH3N3B02D							
LQG15WH3N4S02D LQG15WH3N4C02D 3.4 LQG15WH3N4S02D LQG15WH3N5S02D LQG15WH3N5S02D LQG15WH3N6B02D LQG15WH3N6B02D LQG15WH3N6S02D LQG15WH3N6S02D LQG15WH3N7B02D LQG15WH3N7B02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D S5000			3.3			0.08			
LQG15WH3N4B02D LQG15WH3N4S02D LQG15WH3N5B02D LQG15WH3N5S02D LQG15WH3N6S02D LQG15WH3N6B02D LQG15WH3N6S02D LQG15WH3N6S02D LQG15WH3N7B02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8S02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D S000			-						
LQG15WH3N4C02D 3.4 LQG15WH3N4S02D 0.09 LQG15WH3N5C02D 3.5 LQG15WH3N5S02D 0.09 LQG15WH3N6S02D 0.09 LQG15WH3N6C02D 0.09 LQG15WH3N6S02D 0.09 LQG15WH3N6S02D 0.09 LQG15WH3N7S02D 0.10 LQG15WH3N7S02D 0.10 LQG15WH3N8B02D 0.10 LQG15WH3N8C02D 3.8				1					
LQG15WH3N4S02D LQG15WH3N5B02D LQG15WH3N5S02D LQG15WH3N6S02D LQG15WH3N6S02D LQG15WH3N7B02D LQG15WH3N7B02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D			3.4						
LQG15WH3N5B02D LQG15WH3N5C02D 3.5 LQG15WH3N5S02D LQG15WH3N6B02D 3.6 LQG15WH3N6S02D 5500 LQG15WH3N7B02D 3.7 LQG15WH3N7S02D 0.10 LQG15WH3N8B02D 0.10 LQG15WH3N8C02D 3.8			. .						
LQG15WH3N5C02D 3.5 LQG15WH3N5S02D 0.09 LQG15WH3N6B02D 3.6 LQG15WH3N6S02D 5500 LQG15WH3N7B02D 0.10 LQG15WH3N8B02D 0.10 LQG15WH3N8B02D 0.10 LQG15WH3N8B02D 0.5000				†					
LQG15WH3N5S02D LQG15WH3N6B02D LQG15WH3N6C02D 3.6 LQG15WH3N6S02D LQG15WH3N7B02D LQG15WH3N7C02D 3.7 LQG15WH3N7S02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8C02D 3.8			3.5			n na	5800		
LQG15WH3N6B02D LQG15WH3N6S02D LQG15WH3N7B02D LQG15WH3N7C02D LQG15WH3N7S02D LQG15WH3N7S02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D LQG15WH3N8B02D S5000			5.5			0.03	3000		
LQG15WH3N6C02D 3.6 LQG15WH3N6S02D 5500 LQG15WH3N7B02D 3.7 LQG15WH3N7S02D 0.10 LQG15WH3N8B02D 5000 LQG15WH3N8C02D 3.8		· ·		1					
LQG15WH3N6S02D 5500 LQG15WH3N7B02D 3.7 LQG15WH3N7S02D 0.10 LQG15WH3N8B02D 5000			3.6						
LQG15WH3N7B02D LQG15WH3N7C02D 3.7 LQG15WH3N7S02D LQG15WH3N8B02D LQG15WH3N8C02D 3.8			ა.ნ						
LQG15WH3N7C02D 3.7 LQG15WH3N7S02D 0.10 LQG15WH3N8B02D 3.8 5000				-			5500		
LQG15WH3N7S02D 0.10 LQG15WH3N8B02D 3.8 5000			0.7						
LQG15WH3N8B02D			3./						
LQG15WH3N8B02D 3.8 5000				4		0.10			
							_		
LQG15WH3N8S02D			3.8				5000		
		LQG15WH3N8S02D							

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Customer Part Number	MURATA Part Number	Inductance (nH)	Tolerance	Q (min.)	DC Resistance (Ω max.)	Self Resonant Frequency (MHz min.)	Rated Current	ESD Rank 1C:1kV
			(*1)(refer t	o belov	w comment)		(mA)	
	LQG15WH3N9B02D							
	LQG15WH3N9C02D	3.9			0.09		900	
	LQG15WH3N9S02D							
	LQG15WH4N1B02D							
	LQG15WH4N1C02D	4.1						
	LQG15WH4N1S02D				0.10	5000		
	LQG15WH4N3B02D				0.10	0000		
	LQG15WH4N3C02D	4.3						
	LQG15WH4N3S02D							
	LQG15WH4N7B02D							
	LQG15WH4N7C02D	4.7	B:±0.1nH		0.11		800	
	LQG15WH4N7S02D		C:±0.2nH					
	LQG15WH5N1B02D		S:±0.3nH					
	LQG15WH5N1C02D	5.1	00.0		0.12			
	LQG15WH5N1S02D					4500		
	LQG15WH5N6B02D					+500		
	LQG15WH5N6C02D	5.6						
	LQG15WH5N6S02D							
	LQG15WH5N8B02D]
	LQG15WH5N8C02D	5.8			0.13			
	LQG15WH5N8S02D							
	LQG15WH6N2B02D							
	LQG15WH6N2C02D	6.2				700	700	
	LQG15WH6N2S02D							
	LQG15WH6N8G02D							
	LQG15WH6N8H02D	6.8			0.14	4000		
	LQG15WH6N8J02D							
	LQG15WH7N3G02D							
	LQG15WH7N3H02D	7.3		23	0.17			1C
	LQG15WH7N3J02D						600	
	LQG15WH7N5G02D						000	
	LQG15WH7N5H02D	7.5						
	LQG15WH7N5J02D				0.16			
	LQG15WH8N2G02D				0.10			
	LQG15WH8N2H02D	8.2				3600		
	LQG15WH8N2J02D		_					
	LQG15WH8N7G02D					_		
	LQG15WH8N7H02D	8.7				3500	550	
	LQG15WH8N7J02D	G:±2%	1		0.17			
	LQG15WH9N1G02D],	٠		
	LQG15WH9N1H02D	9.1	H:±3%			3400		
	LQG15WH9N1J02D		J:±5%					
	LQG15WH9N5G02D							
	LQG15WH9N5H02D	9.5			0.21			
	LQG15WH9N5J02D		_			3300	500	
	LQG15WH10NG02D	46.5					- 30	
	LQG15WH10NH02D	10.0			0.19			
	LQG15WH10NJ02D							
	LQG15WH11NG02D	11.0			0.00	0005		
	LQG15WH11NH02D	11.0			0.22	3000		
	LQG15WH11NJ02D		_				450	
	LQG15WH12NG02D							
	LQG15WH12NH02D	12.0			0.24			
	LQG15WH12NJ02D		_			2800		
	LQG15WH13NG02D					_000		
	LQG15WH13NH02D	13.0			0.26		400	
	LQG15WH13NJ02D							

SpecNo.JELF243B-9118B-01

Reference Only

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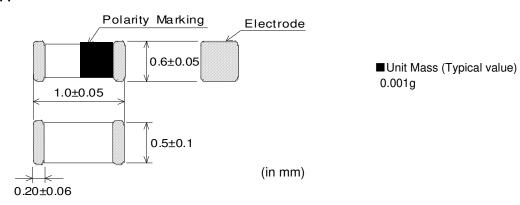
Customer Part Number	MURATA Part Number	Inductance (nH)	Tolerance	Q (min.)	DC Resistance (Ω max.)	Self Resonant Frequency (MHz min.)	Rated Current (mA)	ESD Rank 1C:1kV
	LQG15WH15NG02D		(1)(101011	0 00101				
	LQG15WH15NH02D	15.0		23	0.28		400	
	LQG15WH15NJ02D				0.20			
	LQG15WH16NG02D							
	LQG15WH16NH02D	16.0		20				
	LQG15WH16NJ02D				0.0	0000		
	LQG15WH18NG02D				0.8	2300		
	LQG15WH18NH02D	18.0	0. 1.00/	22				
	LQG15WH18NJ02D		G:±2%				260	1C
	LQG15WH19NG02D		H:±3% J:±5%				260	10
	LQG15WH19NH02D	19.0	0.2576		0.8			
	LQG15WH19NJ02D							
	LQG15WH20NG02D							
	LQG15WH20NH02D	20.0		20				
	LQG15WH20NJ02D				1.1	2100		
	LQG15WH22NG02D				1.1	2100		
	LQG15WH22NH02D	22.0					230	
	LQG15WH22NJ02D							

(*1) Standard Testing Conditions

《Unless otherwise specified》 《In case of doubt》

Temperature : Ordinary Temperature / 15°C to 35°C Temperature : 20°C ± 2°C

4. Appearance and Dimensions



No.	Item	Specification	Test Method
5.1	Inductance	Inductance shall meet item 3.	Measuring Equipment: Keysight 4991A or equivalent Measuring Frequency:100MHz (Inductance) 250MHz (Q) Measuring Condition: Test signal level/about 0dBm Electricallength/10mm Weight/about 1N to 5N Measuring Fixture: Keysight 16197A Position coil under test as shown in below and contact coil with each terminal by adding weight. Polarity marking should be a topside,and polarity
5.2	Q	Q shall meet item 3.	marking should be in the direction of the fixture for position of chip coil. Measuring Method:See P.11 [Electrical Performance:Measuring Method of Inductance/Q]
5.3	DC Resistance	DC Resistance shall meet item 3.	Measuring Equipment:Digital multi meter
5.4	Self Resonant Frequency(S.R.F)	S.R.F shall meet item 3.	Measuring Equipment: Keysight N5230A or equivalent
5.5	Rated Current	Self temperature rise shall be limited to 25°C max.	The allowable current is applied.

6.Q200 Requirement

6.1.Performance (based on Table 5 for Magnetics(Inductors / Transformer)

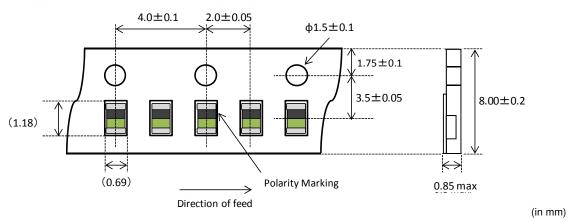
AEC-Q200 Rev.D issued June 1. 2010

		AEC-Q200	Murata Specification / Deviation
No	Stress	Test Method	·
3	High Temperature Exposure	1000hours at 125 deg C Set for 24hours at room temperature, then measured.	Meet Table A after testing. Table A Appearance No damage Inductance Change (at 100MHz) Within ±10%
4	Temperature Cycling	1000cycles -40 deg C to +125 deg C Set for 24hours at room temperature,then measured.	Meet Table A after testing.
7	Biased Humidity	1000hours at 85 deg C, 85%RH unpowered.	Meet Table A after testing.
8	Operational Life	Apply 125 deg C 1000hours Set for 24hours at room temperature, then measured	Meet Table A after testing.
9	External Visual	Visual inspection	No abnormalities
10	Physical Dimension	Meet ITEM 4 (Style and Dimensions)	No defects
12	Resistance to Solvents	Per MIL-STD-202 Method 215	Not Applicable
13	Mechanical Shock	Per MIL-STD-202 Method 213 Condition C : 100g's(0.98N), 6ms, Half sine, 12.3ft/s	Meet Table A after testing.

	AEC-Q200		Murata Specification / Deviation		
No	Stress	Test Method			
14	Vibration	5g's(0.049N) for 20 minutes, 12cycles each of 3 oritentations Test from 10-2000Hz.	Meet Table A after testing.		
15	Resistance to Soldering Heat	No-heating Solder temperature 260C+/-5 deg C Immersion time 10s	Meet Table A after testing. Pre-heating 150C +/-10 deg C, 60s to 90s		
17	ESD	Per AEC-Q200-002	ESD Rank: refer to the Item3 (Rating). Meet Table A after testing		
18	Solderbility	Per J-STD-002	Method b : Not Applicable 90% of the terminations is to be soldered.		
19	Electrical Characterization	Measured : Inductance	No defects		
20	Flammability	Per UL-94	Not Applicable		
21	Board Flex	Epoxy-PCB(1.6mm) Deflection 2mm(min) Holding time 60s	Meet Table B after testing. Table B Appearance No damage DC resistance Change Within ±10%		
22	Terminal Strength	Per AEC-Q200-006 A force of 17.7N for 60s	Murata Deviation Request: 5N No defects		

7. Specification of Packaging

7.1 Appearance and Dimensions of paper tape (8mm-wide)



7.2 Specification of Taping

- (1) Packing quantity (standard quantity)
 - 10,000 pcs. / reel
- (2) Packing Method

Products shall be packed in the cavity of the base tape and sealed by top tape.

(3) Sprocket hole

The sprocket holes are to the right as the tape is pulled toward the user.

(4) Spliced point

Base tape and Top tape has no spliced point.

(5) Missing components number

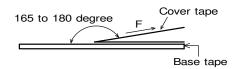
Missing components number within 0.1 % of the number per reel or 1 pc., whichever is greater, and are not continuous. The Specified quantity per reel is kept.

7.3 Pull Strength

- .	
Top tape	5N min.

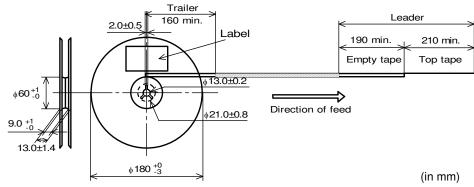
7.4 Peeling off force of cover tape

Speed of Peeling off	300mm/min
Peeling off force	0.1N to 0.6N
	(minimum value is typical)



7.5 Dimensions of Leader-tape, Trailer and Reel

There shall be leader-tape (top tape and empty tape) and trailer-tape (empty tape) as follows.



7.6 Marking for reel

Customer part number, MURATA part number, Inspection number(*1) ,RoHS Marking(*2), Quantity etc \cdots

*1) < Expression of Inspection No.>

$$\frac{\square\square}{(1)} \frac{OOOO}{(2)} \frac{\times \times \times}{(3)}$$

- (1) Factory Code
- (2) Date First digit: Year / Last digit of year Second digit: Month / Jan. to Sep. → 1 to 9, Oct. to Dec. → O, N, D
 - Third, Fourth digi: Day
- (3) Serial No.
- *2) < Expression of RoHS Marking>

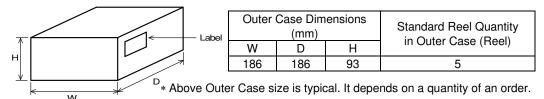
ROHS
$$-\underline{Y}(\underline{\Delta})$$

- (1) RoHS regulation conformity parts.
- (2) MURATA classification number

7.7 Marking for Outside package (corrugated paper box)

Customer name, Purchasing order number, Customer part number, MURATA part number, RoHS Marking(*2) ,Quantity, etc ···

7.8. Specification of Outer Case



8. A Caution

8.1 Caution(Rating)

Do not exceed maximum rated current of the product. Thermal stress may be transmitted to the product and short/open circuit of the product or falling off the product may be occurred.

8.2 Fail-safe

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

8.3 Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment (4) Power plant control equipment
- (5) Medical equipment
- (6) Transportation equipment (trains, ships, etc.)
- (7) Traffic signal equipment
- (8) Disaster prevention / crime prevention equipment
- (9) Data-processing equipment
- (10) Applications of similar complexity and /or reliability requirements to the applications listed in the above

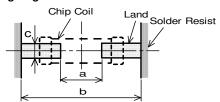
9. Notice

Products can only be soldered with reflow.

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

9.1 Land pattern designing



а	0.5
b	1.2
С	0.65

(in mm)

9.2 Flux, Solder

·Use rosin-based flux.

Don't use highly acidic flux with halide content exceeding 0.2(wt)% (chlorine conversion value). Don't use water-soluble flux.

- ·Use Sn-3.0Ag-0.5Cu solder.
- Standard thickness of solder paste : $100 \, \mu m$ to $150 \, \mu m$.

9.3 Reflow soldering conditions

•Inductance value may be changed a little due to the amount of solder.

So, the chip coil shall be soldered by reflow so that the solder volume can be controlled.

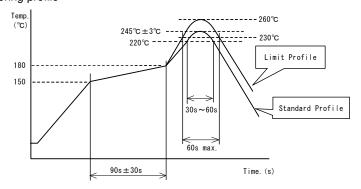
•Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max. Cooling into solvent after soldering also should be in such a way that the temperature difference is limited to 100°C max.

Insufficient pre-heating may cause cracks on the product, resulting in the deterioration of products quality.

•Standard soldering profile and the limit soldering profile is as follows.

The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.

Reflow soldering profile



	Standard Profile	Limit Profile
Pre-heating	150°C~180°	C ,90s±30s
Heating	above 220°C, 30s∼60s	above 230°C, 60s max.
Peak temperature	245°C±3°C	260°C,10s
Cycle of reflow	2 times	2 times

9.4 Reworking with soldering iron

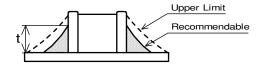
The following conditions must be strictly followed when using a soldering iron.

Pre-heating	150°C,1 min
Tip temperature	350°C max.
Soldering iron output	80W max.
Tip diameter	¢3mm max.
Soldering time	3(+1,-0)s
Time	2 times

Note :Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the products due to the thermal shock.

9.5 Solder Volume

- · Solder shall be used not to be exceed the upper limits as shown below.
- Accordingly increasing the solder volume, the mechanical stress to Chip is also increased.
 Exceeding solder volume may cause the failure of mechanical or electrical performance.



1/3T≦t≦T T:thickness of product

9.6 Mount Shock

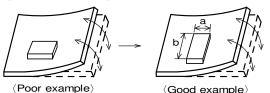
Over Mechanical stress to products at mounting process causes crack and electrical failure etc.

9.7 Product's location

The following shall be considered when designing and laying out P.C.B.'s.

 P.C.B. shall be designed so that products are not subjected to the mechanical stress due to warping the board.



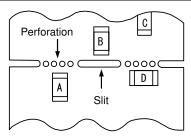


Products shall be located in the sideways direction (Length:a < b) to the mechanical stress.

(2) Components location on P.C.B. separation.

It is effective to implement the following measures, to reduce stress in separating the board. It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

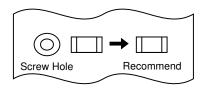
Contents of Measures	Stress Level
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D*1
(2) Add slits in the board separation part.	A > B
(3) Keep the mounting position of the component away from the board separation surface	A > C



*1 A > D is valid when stress is added vertically to the perforation as with Hand Separation. If a Cutting Disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.

(3) Mounting Components Near Screw Holes

When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw. Mount the component in a position as far away from the screw holes as possible.



9.8 Cleaning Conditions

Products shall be cleaned on the following conditions.

- (1) Cleaning temperature shall be limited to 60°C max.(40°C max for IPA.)
- (2) Ultrasonic cleaning shall comply with the following conditions with avoiding the resonance phenomenon at the mounted products and P.C.B.

Power: 20 W / I max. Frequency: 28kHz to 40kHz Time: 5 min max.

- (3) Cleaner
 - Alcohol type cleaner Isopropyl alcohol (IPA)
 - 2. Aqueous agent PINE ALPHA ST-100S
- (4) There shall be no residual flux and residual cleaner after cleaning. In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.
- (5) Other cleaning Please contact us.

9.9 Resin coating

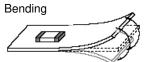
The inductance value may change and/or it may affect on the product's performance due to high cure-stress of resin to be used for coating / molding products. So please pay your careful attention when you select resin.

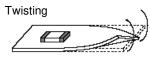
In prior to use, please make the reliability evaluation with the product mounted in your application set.

9.10 Handling of a substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.





9.11 Storage and Handling Requirements

(1) Storage period

Use the products within 6 months after deliverd.

Solderability should be checked if this period is exceeded.

- (2) Storage conditions
 - Products should be stored in the warehouse on the following conditions.

Temperature: -10°C to 40°C

Humidity: 15% to 85% relative humidity No rapid change on temperature and humidity

Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.

- Products should be storaged on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be storaged in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storaged under the airtight packaged condition.
- (3) Handling Condition

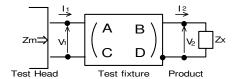
Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

10. \triangle Note

- (1) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the reference specifications.
- (3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.

-<Electrical Performance:Measuring Method of Inductance/Q>-

(1) Residual elements and stray elements of test fixture can be described by F-parameter shown in following.



$$\left(\begin{array}{c} V_1 \\ I_1 \end{array}\right) = \left(\begin{array}{cc} A & B \\ C & D \end{array}\right) \, \left(\begin{array}{c} V_2 \\ I_2 \end{array}\right)$$

(2) The impedance of chip coil Zx and measured value Zm can be described by input/output current/voltage.

$$Zm = \frac{V_1}{I_1}$$
 , $Zx = \frac{V_2}{I_2}$

(3) Thus, the relation between Zx and Zm is following;

$$Z = \alpha \frac{Zm - \beta}{1 - Zm \Gamma}$$
 where, $\alpha = D / A = 1$
 $\beta = B / D = Zsm - (1 - Yom Zsm)Zss$
 $\Gamma = C / A = Yom$

Zsm:measured impedance of short chip Zss:residual impedance of short chip (0.556nH) Yom:measured admittance when opening the fixture

(4) Lx and Qx shall be calculated with the following equation.

$$\text{Lx=} \ \ \frac{\text{Im}(\text{Zx})}{2\, \text{nf}} \ \ \, \text{Qx=} \ \ \frac{\text{Im}(\text{Zx})}{\text{Re}(\text{Zx})} \ \ \, \text{Lx :Inductance of chip coil} \\ \text{Qx:Q of chip coil} \\ \text{f :Measuring frequency}$$